

1

2

3

4

REVISIONS				
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE
A0	N/A		INITIAL RELEASE	/
A1	N/A		图面升级整理图面	2024.12.4

A

A

DATE CODE

DATE CODE

B

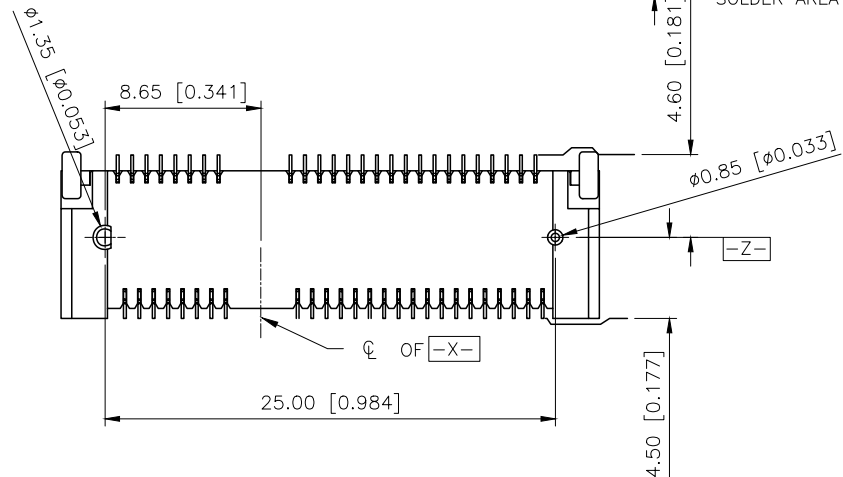
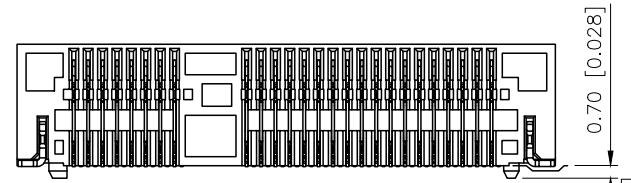
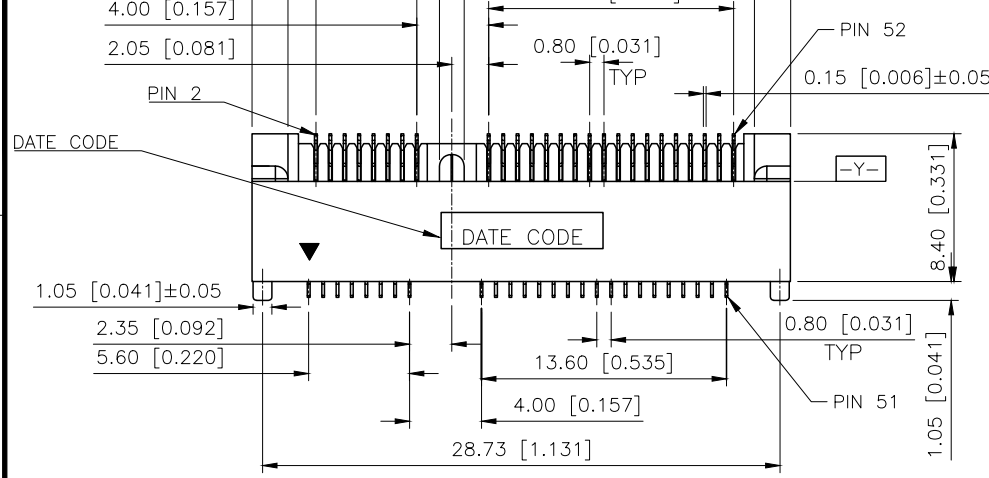
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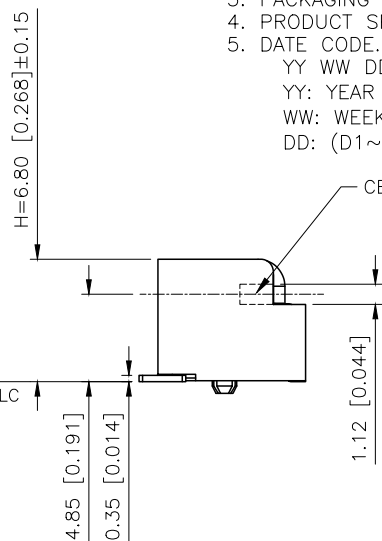
C

D

D



NOTES:
1. MATERIAL:
HOUSING: THERMOPLASTIC, HIGH TEMP, UL94V-0, BLACK COLOR,
CONTACTS: COPPER ALLOY.
PEGS: COPPER ALLOY.
2. FINISH:
CONTACTS: SELECTED GOLD PLATING ON THE CONTACT AREA,
1u" MIN. GOLD PLATING ON THE SOLDER TAILS,
50 u" MIN. NICKEL UNDER PLATING OVER ALL.
PEGS: 120u" MIN. MATTE-TIN OVER 50u" MIN. NICKEL.
3. PACKAGING SPECIFICATION: 9130404001
4. PRODUCT SPECIFICATION: PS-MINI PCI-E-01
5. DATE CODE.
YY WW DD
YY: YEAR (19: 2019)
WW: WEEK (25: THE 25TH WEEK)
DD: (D1~D7: SUNDAY~SATURDAY)



PART NO.:

X1304 W V S-52 D-LP V01
① ② ③ ④ ⑤ ⑥ ⑦ ⑧

- ①Series No
- ②Category:W-Wafer
- ③Welding Board Angle:V-Stright 180°
- ④Welding Way:S-SMT
- ⑤Row No.Pin No.: 52Pin;
- ⑥Height:A:H=4.00mm;B:H=5.20mm;C:H=5.60mm;D:H=6.80mm
E:H=7.00mm;F:H=8.00mm;G:H=9.00mm;H:H=9.90mm
- ⑦Material:LP-LCP UL 94V-0
- ⑧Plating Category: V01-Gold Flash
V10-Gold 10U"
V30-Gold 30U"

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	



DESIGN	阿树	VIEW:	MODEL TYPE: MINI PCI EXPRESS 6.8mm HEIGHT
CHECKED		UNIT: mm/in	PART NO.: X1304WVS-52D-LPV01
APPROVED		SIZE: A4	DWG NO.:

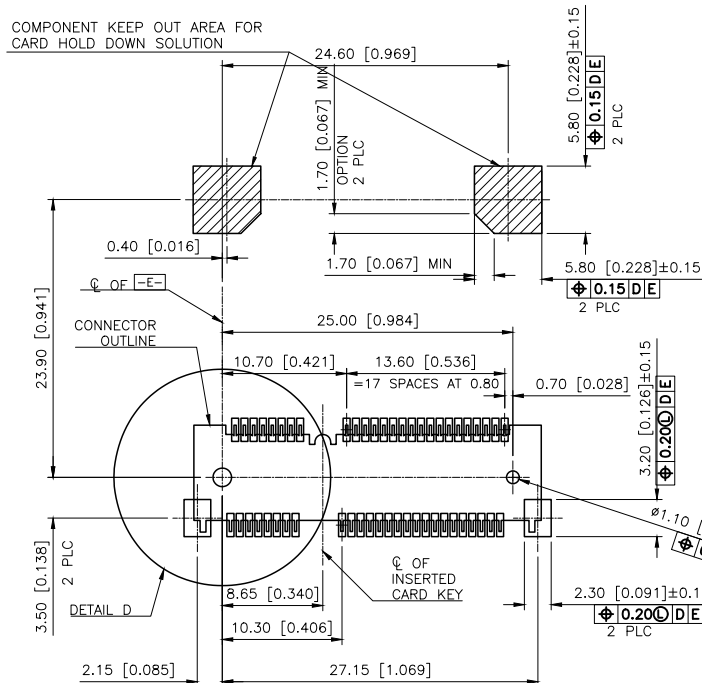
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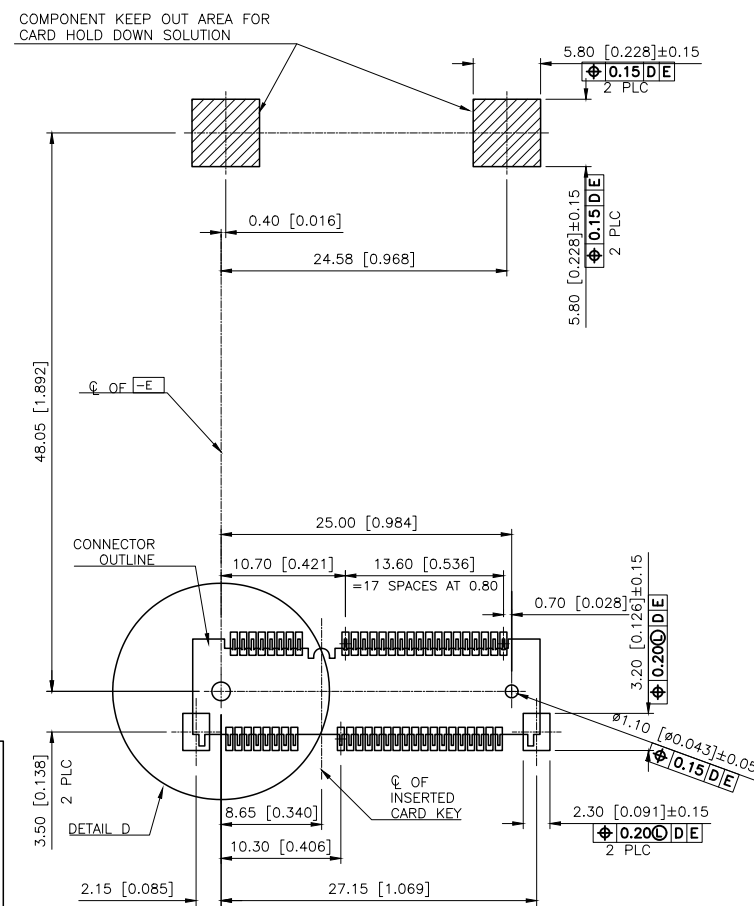
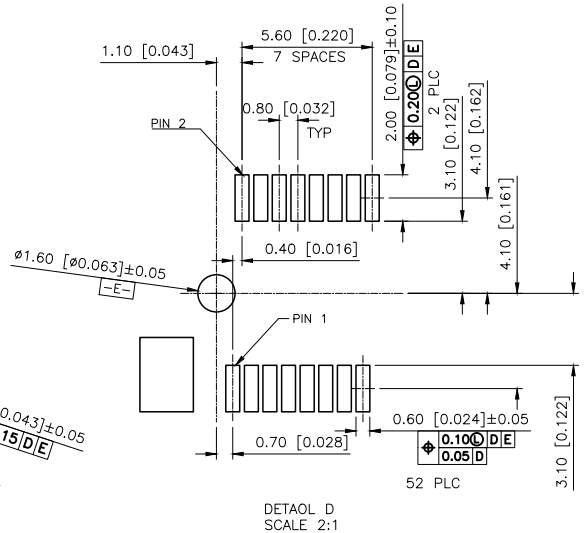
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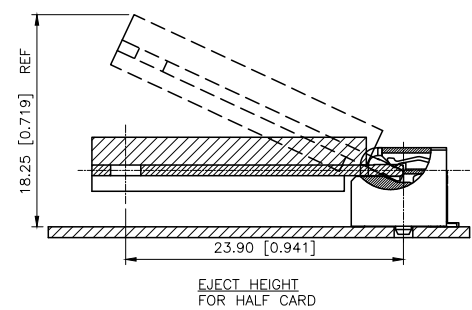
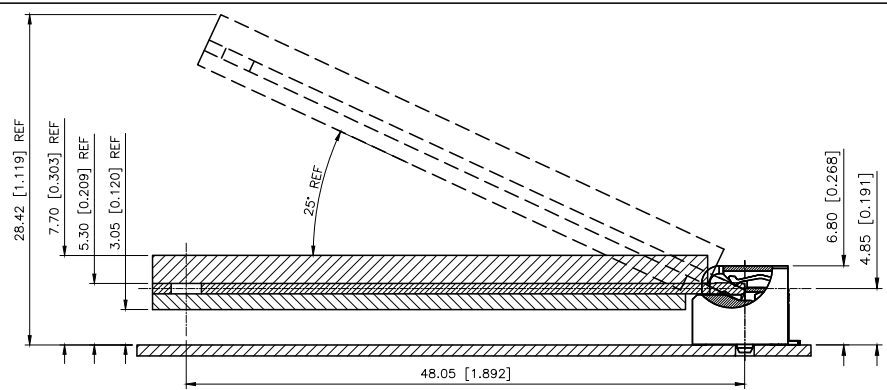
REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2024.12.4	阿树



-D- IS THE TOP SURFACE OF PCB
Recommended P.C. BOARD PATTERN LAYOUT
FOR HALF CARD CONNECTOR(TOP VIEW)



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Recommended P.C. BOARD PATTERN LAYOUT
FOR HALF CARD CONNECTOR(TOP VIEW)



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X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	

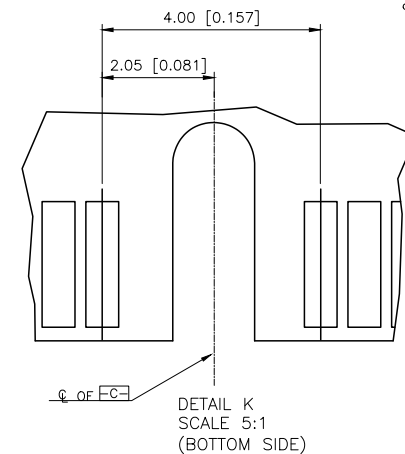
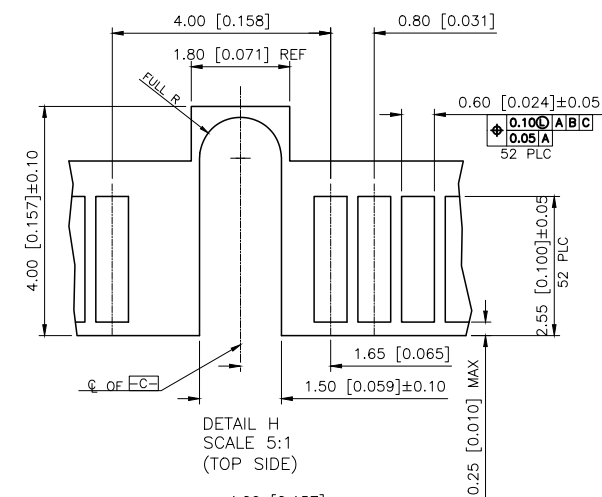
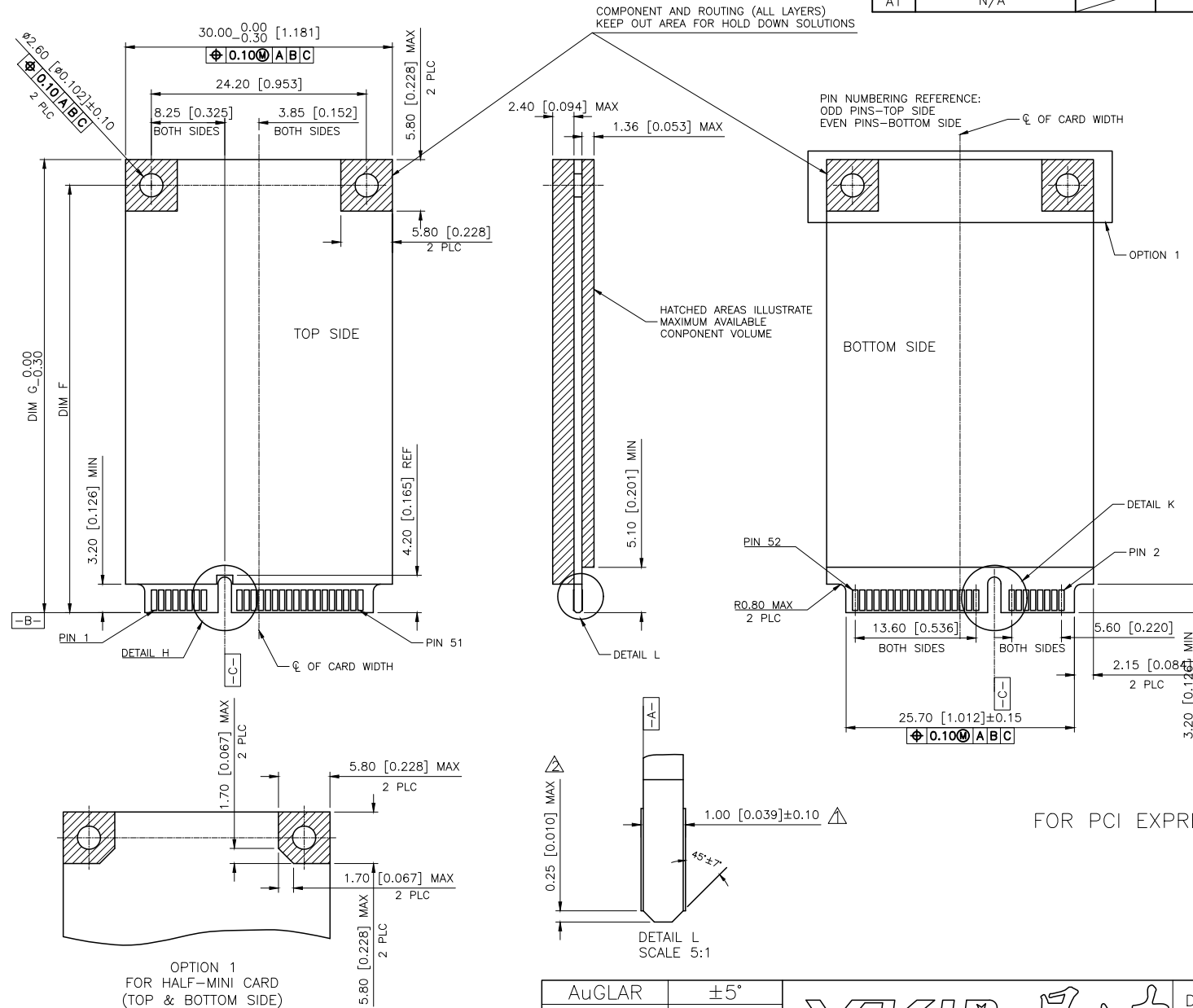


DESIGN	阿树	VIEW:	
CHECKED		UNIT:	mm/in
APPROVED		SIZE:	A4

MODEL TYPE:	MINI PCI EXPRESS 6.8mm HEIGHT
PART NO.:	X1304WVS-52D-LPV01
DWG NO.:	

DIM F	DIM G	
48.05	50.95	FULL-MINI CARD
23.90	26.80	HALF-MINI CARD

	REVISIONS				
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2024.12.4	阿树



FOR PCI EXPRESS MINI CARD

- NOTES:
-  CARD THICKNESS APPLIES ACROSS TABS AND INCLUDES PLATING AND/OR METALLIZATION.
-  EDGE BEVEL MUST BE PRESENT AND FREE OF CUTTING BURRS FROM PCB AND CONTACT MATERIALS.

AuGLAR	$\pm 5^\circ$
X.	± 0.40
X.x	± 0.30
X.xx	± 0.20
X.xxx	± 0.15
UNSPECIFIED TOLERANCES	



DESIGN	阿树	VIEW: 	MODEL TYPE: MINI PCI EXPRESS 6.8mm HEIGHT		
CHECKED		UNIT: mm/in	PART NO.: X1304WVS-52D-LPV01		
APPROVED		SIZE: A4	DWG NO.:		
PRECISION CO., LIMITED			SCALE	PAGE	REVISION
			N/A	3/4	A1

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48.05	50.95	FULL CARD
23.90	26.80	HALF CARD

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